

AMENDMENTS TO THE SPECIFICATION:

Please **amend the paragraph beginning on page 2, line 21**, as follows:

b1 It is the object of the present invention to provide, in a substrate section of the kind mentioned in the ~~introductory part of Claim 1~~ beginning hereof, an embodiment of the carrier layer provided in a releasing aid, by means of which embodiment the leaking-out of pressure-sensitive adhesive in cold flow can be prevented easily and with simple means, thus facilitating easy withdrawal of substrate sections from a package which is open only at one side.
